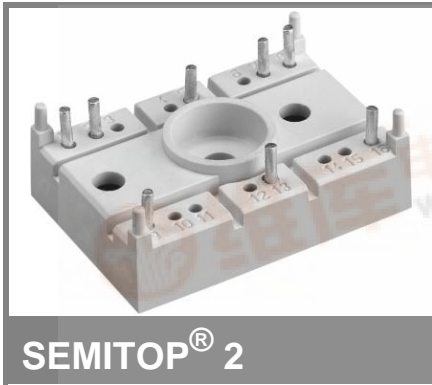


# SK 20 GD 065



## IGBT Module

### SK 20 GD 065

#### Target Data

#### Features

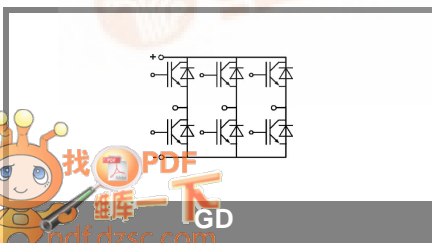
- Compact design
- One screw mounting
- Heat transfer and isolation through direct copper bonded aluminium oxide ceramic (DCB)
- N channel, Ultrafast NPT technology IGBT
- CAL technology FWD
- High short circuit capability
- Low tail current with low temperature dependence

#### Typical Applications

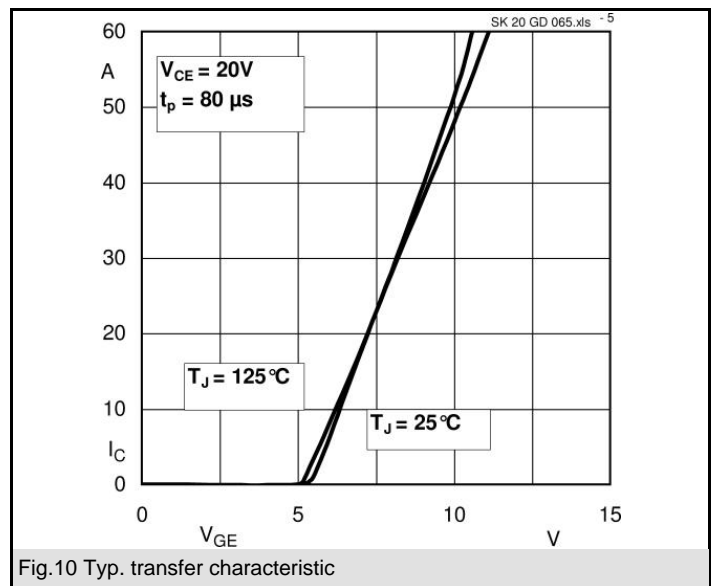
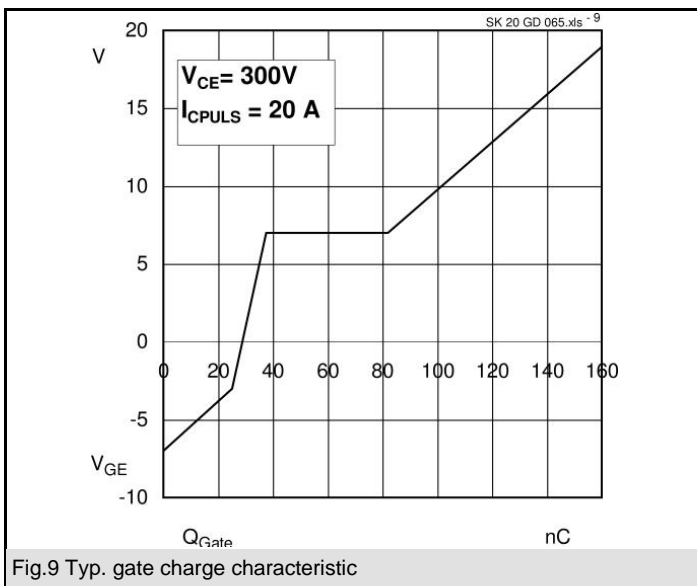
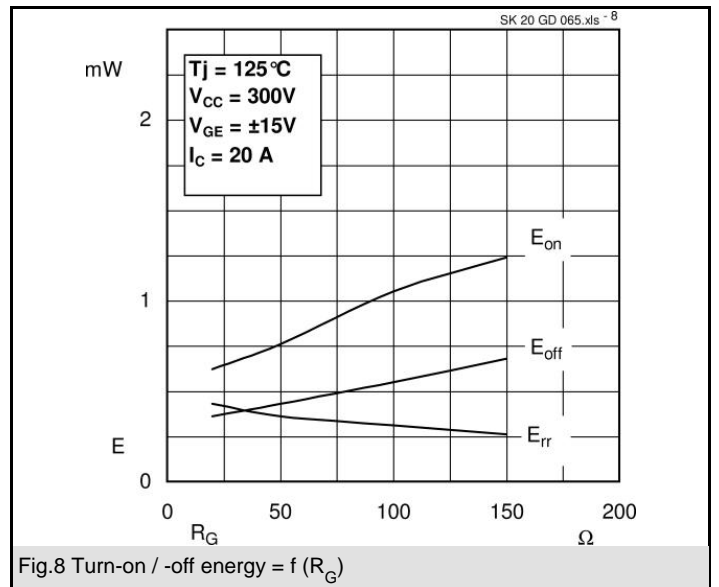
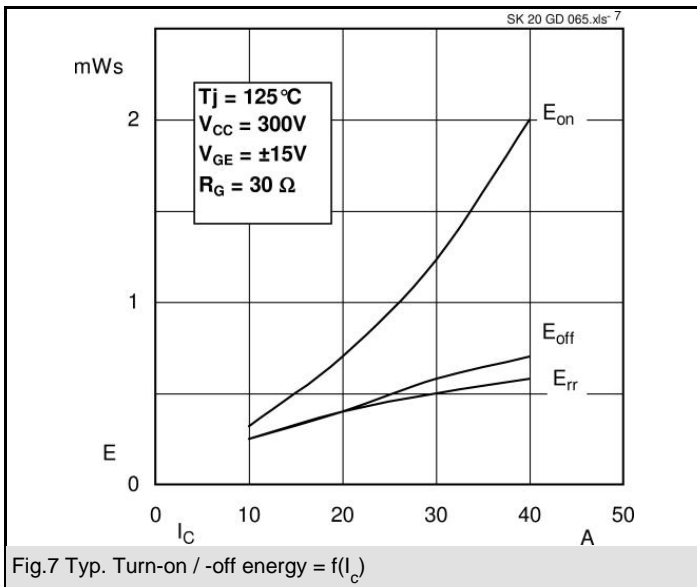
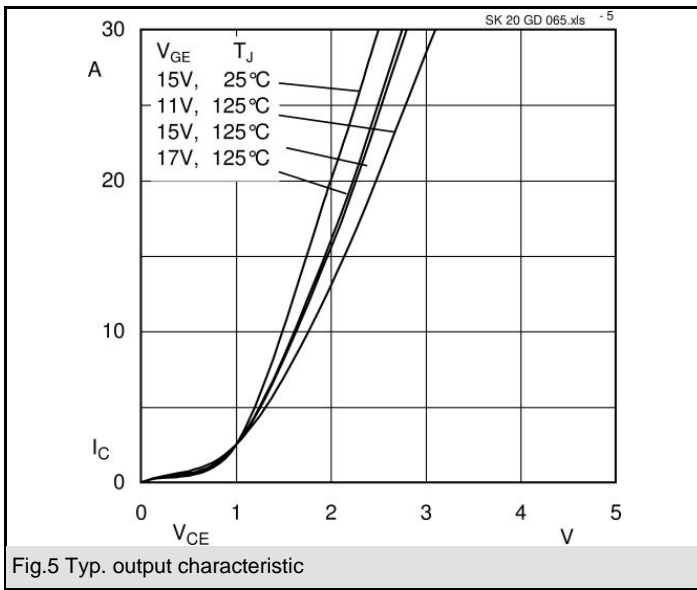
- Switching ( not for linear use )
- Inverter
- Switched mode power supplies
- UPS

Absolute Maximum Ratings		T <sub>s</sub> = 25 °C, unless otherwise specified	
Symbol	Conditions	Values	Units
<b>IGBT</b>			
V <sub>CES</sub>		600	V
V <sub>GES</sub>		± 20	V
I <sub>C</sub>	T <sub>s</sub> = 25 (80) °C;	24 (17)	A
I <sub>CM</sub>	t <sub>p</sub> < 1 ms; T <sub>s</sub> = 25 (80) °C;	48 (34)	A
T <sub>j</sub>		- 40 ... + 150	°C
<b>Inverse/Freewheeling CAL diode</b>			
I <sub>F</sub>	T <sub>s</sub> = 25 (80) °C;	22 (15)	A
I <sub>FM</sub> = - I <sub>CM</sub>	t <sub>p</sub> < 1 ms; T <sub>s</sub> = 25 (80) °C;	44 (30)	A
T <sub>j</sub>		- 40 ... + 150	°C
T <sub>stg</sub>	Terminals, 10 s	- 40 ... + 125	°C
T <sub>sol</sub>		260	°C
V <sub>isol</sub>	AC 50 Hz, r.m.s. 1 min. / 1 s	2500 / 3000	V

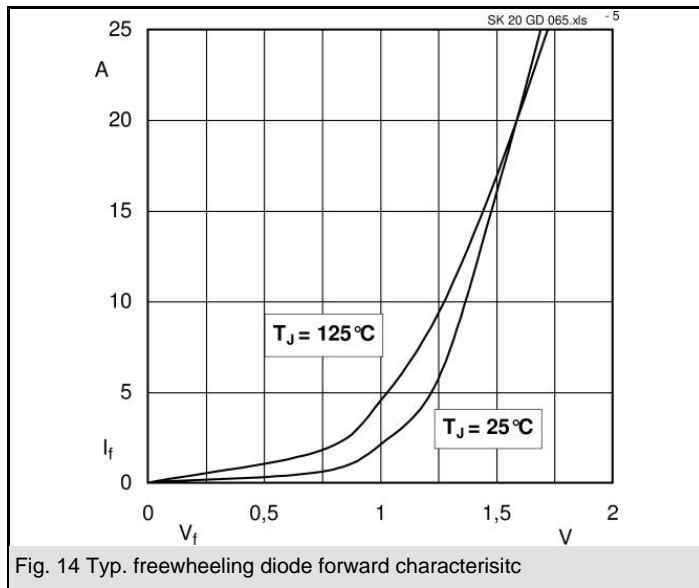
Characteristics		T <sub>s</sub> = 25 °C, unless otherwise specified			
Symbol	Conditions	min.	typ.	max.	Units
<b>IGBT</b>					
V <sub>CE(sat)</sub>	I <sub>C</sub> = 20 A, T <sub>j</sub> = 25 (125) °C		2 (2,2)		V
V <sub>GE(th)</sub>	V <sub>CE</sub> = V <sub>GE</sub> ; I <sub>C</sub> = 0,0005 A	3	4	5	V
C <sub>ies</sub>	V <sub>CE</sub> = 0 V; V <sub>GE</sub> = 0 V; 1 MHz		1,2		nF
R <sub>th(j-s)</sub>	per IGBT per module			1,7	K/W
under following conditions:					
t <sub>d(on)</sub>	V <sub>CC</sub> = 300 V, V <sub>GE</sub> = ± 15 V		36		ns
t <sub>r</sub>	I <sub>C</sub> = 20 A, T <sub>j</sub> = 125 °C		30		ns
t <sub>d(off)</sub>	R <sub>Gon</sub> = R <sub>Goff</sub> = 30 Ω		250		ns
t <sub>f</sub>			60		ns
E <sub>on</sub> + E <sub>off</sub>	Inductive load		1,04		mJ
<b>Inverse/Freewheeling CAL diode</b>					
V <sub>F</sub> = V <sub>EC</sub>	I <sub>F</sub> = 20 A; T <sub>j</sub> = 25 (125) °C		1,6 (1,9)	1,9 (1,9)	V
V <sub>(TO)</sub>	T <sub>j</sub> = 25 (125) °C		1 (0,9)	1,1 (1)	V
r <sub>T</sub>	T <sub>j</sub> = 25 (125) °C		30 (33)	40 (47)	mΩ
R <sub>th(j-s)</sub>				1,7	K/W
under following conditions:					
I <sub>RRM</sub>	I <sub>F</sub> = 20 A; V <sub>R</sub> = 300 V		27		A
Q <sub>rr</sub>	di <sub>F</sub> /dt = 1350 A/μs		2,3		μC
E <sub>off</sub>	V <sub>GE</sub> = 0 V; T <sub>j</sub> = 125 °C		0,4		mJ
<b>Mechanical data</b>					
M1	mounting torque			2	Nm
w			21		g
Case	SEMITOP® 2		T 47		



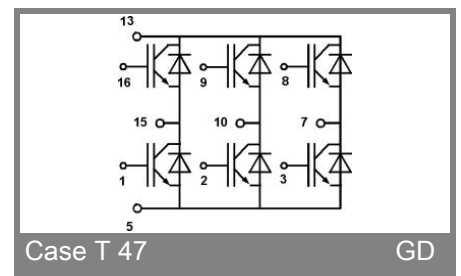
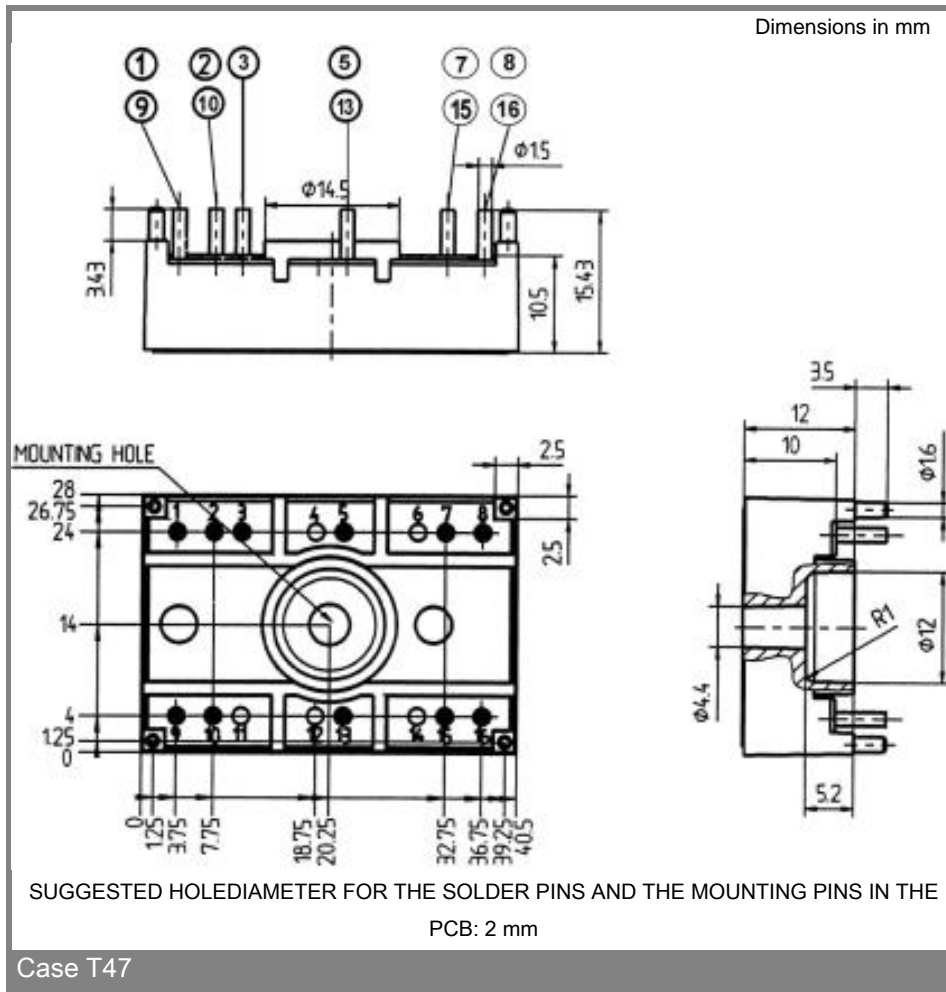
# SK 20 GD 065



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This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

This technical information specifies semiconductor devices but promises no characteristics. No warranty or guarantee expressed or implied is made regarding delivery, performance or suitability.